



SN74LVC2G126(LX) Dual Buffer/Line Driver; 3-state

Product Specification

Specification Revision History:

Version	Date	Description
2021-05-A1	2021-05	New
2023-04-B1	2023-04	Update the template



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1、General Description

The SN74LVC2G126 is a dual non-inverting buffer/line driver with 3-state outputs. Each 3-state output is controlled by an output enable input (pin nOE). A LOW-level at pin nOE causes the output to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3V or 5V devices. This feature allows the use of the SN74LVC2G126 as a translator in a mixed 3.3V and 5V environment.

Features:

- Wide supply voltage range from 1.65V to 5.5V
- 5V tolerant input/output for interfacing with 5V logic
- $\pm 24\text{mA}$ output drive ($V_{CC}=3.0\text{V}$)
- CMOS low power consumption
- Specified from -40°C to $+125^{\circ}\text{C}$
- Packaging information: TSSOP8/VSSOP8

Ordering Information:

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
SN74LVC2G126DCT(LX)	TSSOP8	BSXX	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 3.0mm×3.0mm Pin spacing: 0.65mm
SN74LVC2G126DCU(LX)	VSSOP8	BSXX	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 2.0mm×2.3mm Pin spacing: 0.50mm

Note 1: "XX" refers to variable content, meaning year and package batch serial number.

Note 2: If the physical information is inconsistent with the ordering information, please refer to the actual product.

2、Block Diagram And Pin Description

2.1、Block Diagram

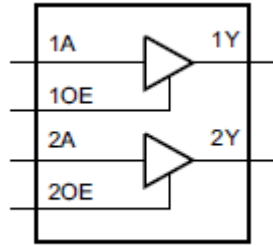


Figure 1. Logic symbol

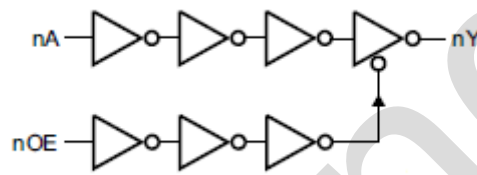
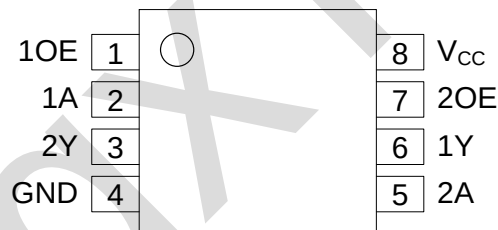


Figure 2. Logic diagram (one gate)

2.2、Pin Configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	1OE	output enable input (active HIGH)
2	1A	data input
3	2Y	data output
4	GND	ground (0V)
5	2A	data input
6	1Y	data output
7	2OE	output enable input (active HIGH)
8	V _{CC}	supply voltage



2.4、Function Table

Input		Output
nOE	nA	nY
H	L	L
H	H	H
L	X	Z

Note: H=HIGH voltage level; L=LOW voltage level; X=don't care; Z=high-impedance OFF-state.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND(ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+6.5	V
input clamping current	I_{IK}	$V_I < 0V$	-50	-	mA
input voltage	V_I	-	-0.5	+6.5	V
Output clamping current	I_{OK}	$V_O > V_{CC}$ or $V_O < 0V$	-	± 50	mA
output voltage	V_O	Active mode	-0.5	$V_{CC}+0.5$	V
		Power-down mode	-0.5	+6.5	V
output current	I_O	$V_O=0V$ to V_{CC}	-	± 50	mA
supply current	I_{CC}	-	-	100	mA
ground current	I_{GND}	-	-100	-	mA
storage temperature	T_{stg}	-	-65	+150	°C
total power dissipation	P_{tot}	-	-	300	mW
Soldering temperature	T_L	10s	260		°C

Note: When $V_{CC}=0V$ (Power-down mode), the output voltage can be 5.5V in normal operation.

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{CC}	-	1.65	-	5.5	V
input voltage	V_I	-	0	-	5.5	V
output voltage	V_O	Active mode	0	-	V_{CC}	V
		$V_{CC}=0V$; Power-down mode	0	-	5.5	V
ambient temperature	T_{amb}	-	-40	-	+125	°C



3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	$V_{CC}=1.65\text{V}$ to 1.95V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC}=2.3\text{V}$ to 2.7V	1.7	-	-	V
		$V_{CC}=2.7\text{V}$ to 3.6V	2.0	-	-	V
		$V_{CC}=4.5\text{V}$ to 5.5V	$0.7 \times V_{CC}$	-	-	V
LOW-level input voltage	V_{IL}	$V_{CC}=1.65\text{V}$ to 1.95V	-	-	$0.35 \times V_{CC}$	V
		$V_{CC}=2.3\text{V}$ to 2.7V	-	-	0.7	V
		$V_{CC}=2.7\text{V}$ to 3.6V	-	-	0.8	V
		$V_{CC}=4.5\text{V}$ to 5.5V	-	-	$0.3 \times V_{CC}$	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}	$I_O = -100\mu\text{A}; V_{CC}=1.65\text{V}$ to 5.5V	$V_{CC} - 0.1$	-	V
			$I_O = -4\text{mA}; V_{CC}=1.65\text{V}$	1.2	-	V
			$I_O = -8\text{mA}; V_{CC}=2.3\text{V}$	1.9	-	V
			$I_O = -12\text{mA}; V_{CC}=2.7\text{V}$	2.2	-	V
			$I_O = -24\text{mA}; V_{CC}=3.0\text{V}$	2.3	-	V
			$I_O = -32\text{mA}; V_{CC}=4.5\text{V}$	3.8	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}	$I_O = 100\mu\text{A}; V_{CC}=1.65\text{V}$ to 5.5V	-	0.10	V
			$I_O = 4\text{mA}; V_{CC}=1.65\text{V}$	-	0.45	V
			$I_O = 8\text{mA}; V_{CC}=2.3\text{V}$	-	0.30	V
			$I_O = 12\text{mA}; V_{CC}=2.7\text{V}$	-	0.40	V
			$I_O = 24\text{mA}; V_{CC}=3.0\text{V}$	-	0.55	V
			$I_O = 32\text{mA}; V_{CC}=4.5\text{V}$	-	0.55	V
input leakage current	I_I	$V_I = 5.5\text{V}$ or GND; $V_{CC} = 0\text{V}$ to 5.5V	-	-	± 1	μA
OFF-state output current	I_{OZ}	$V_I = V_{IH}$ or $V_{IL}; V_O = 5.5\text{V}$ or GND; $V_{CC} = 3.6\text{V}$	-	-	± 2	μA
power-off leakage current	I_{OFF}	V_I or $V_O = 5.5\text{V}; V_{CC} = 0\text{V}$	-	-	± 2	μA
supply current	I_{CC}	$V_I = 5.5\text{V}$ or GND; $V_{CC} = 1.65\text{V}$ to $5.5\text{V}; I_O = 0\text{A}$	-	-	4	μA
additional supply current	ΔI_{CC}	per pin; $V_I = V_{CC} - 0.6\text{V}; I_O = 0\text{A}; V_{CC} = 2.3\text{V}$ to 5.5V	-	-	500	μA
input capacitance	C_I	-	-	2	-	pF

Note: All typical values are measured at $V_{CC} = 3.3\text{V}$ and $T_{amb} = 25^{\circ}\text{C}$.



3.3.2、DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	$V_{CC}=1.65\text{V to }1.95\text{V}$	$0.65 \times V_{CC}$	-	-	V
		$V_{CC}=2.3\text{V to }2.7\text{V}$	1.7	-	-	V
		$V_{CC}=2.7\text{V to }3.6\text{V}$	2.0	-	-	V
		$V_{CC}=4.5\text{V to }5.5\text{V}$	$0.7 \times V_{CC}$	-	-	V
LOW-level input voltage	V_{IL}	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	-	$0.35 \times V_{CC}$	V
		$V_{CC}=2.3\text{V to }2.7\text{V}$	-	-	0.7	V
		$V_{CC}=2.7\text{V to }3.6\text{V}$	-	-	0.8	V
		$V_{CC}=4.5\text{V to }5.5\text{V}$	-	-	$0.3 \times V_{CC}$	V
HIGH-level output voltage	V_{OH}	$I_O = -100\mu\text{A}; V_{CC}=1.65\text{V to }5.5\text{V}$	$V_{CC} - 0.1$	-	-	V
		$I_O = -4\text{mA}; V_{CC}=1.65\text{V}$	0.95	-	-	V
		$I_O = -8\text{mA}; V_{CC}=2.3\text{V}$	1.7	-	-	V
		$I_O = -12\text{mA}; V_{CC}=2.7\text{V}$	1.9	-	-	V
		$I_O = -24\text{mA}; V_{CC}=3.0\text{V}$	2.0	-	-	V
		$I_O = -32\text{mA}; V_{CC}=4.5\text{V}$	3.4	-	-	V
LOW-level output voltage	V_{OL}	$I_O = 100\mu\text{A}; V_{CC}=1.65\text{V to }5.5\text{V}$	-	-	0.10	V
		$I_O = 4\text{mA}; V_{CC}=1.65\text{V}$	-	-	0.70	V
		$I_O = 8\text{mA}; V_{CC}=2.3\text{V}$	-	-	0.45	V
		$I_O = 12\text{mA}; V_{CC}=2.7\text{V}$	-	-	0.60	V
		$I_O = 24\text{mA}; V_{CC}=3.0\text{V}$	-	-	0.80	V
		$I_O = 32\text{mA}; V_{CC}=4.5\text{V}$	-	-	0.80	V
input leakage current	I_I	$V_I = 5.5\text{V or GND}; V_{CC} = 0\text{V to }5.5\text{V}$	-	-	± 1	μA
OFF-state output current	I_{OZ}	$V_I = V_{IH} \text{ or } V_{IL}; V_O = 5.5\text{V or GND}; V_{CC} = 3.6\text{V}$	-	-	± 2	μA
power-off leakage current	I_{OFF}	$V_I \text{ or } V_O = 5.5\text{V}; V_{CC} = 0\text{V}$	-	-	± 2	μA
supply current	I_{CC}	$V_I = 5.5\text{V or GND}; V_{CC} = 1.65\text{V to }5.5\text{V}; I_O = 0\text{A}$	-	-	4	μA
additional supply current	ΔI_{CC}	per pin; $V_I = V_{CC} - 0.6\text{V}; I_O = 0\text{A}; V_{CC} = 2.3\text{V to }5.5\text{V}$	-	-	500	μA



3.3.3、AC Characteristics 1

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ. ^[1]	Max.	Unit
nA to nY propagation delay	t_{PLH}, t_{PHL}	see Figure 4	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	11.7	17.6 ns
			$V_{CC}=2.3\text{V to }2.7\text{V}$	-	7.8	11.7 ns
			$V_{CC}=2.7\text{V}$	-	8.4	12.6 ns
			$V_{CC}=3.0\text{V to }3.6\text{V}$	-	7.2	10.8 ns
			$V_{CC}=4.5\text{V to }5.5\text{V}$	-	5.7	8.6 ns
nOE to nY enable time	t_{PZH}, t_{PZL}	see Figure 5	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	12.3	18.5 ns
			$V_{CC}=2.3\text{V to }2.7\text{V}$	-	7.8	11.7 ns
			$V_{CC}=2.7\text{V}$	-	8.4	12.6 ns
			$V_{CC}=3.0\text{V to }3.6\text{V}$	-	7.2	10.8 ns
			$V_{CC}=4.5\text{V to }5.5\text{V}$	-	5.4	8.1 ns
nOE to nY disable time	t_{PLZ}, t_{PHZ}	see Figure 5	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	9.9	14.9 ns
			$V_{CC}=2.3\text{V to }2.7\text{V}$	-	5.7	8.6 ns
			$V_{CC}=2.7\text{V}$	-	9	13.5 ns
			$V_{CC}=3.0\text{V to }3.6\text{V}$	-	7.5	11.3 ns
			$V_{CC}=4.5\text{V to }5.5\text{V}$	-	5.4	8.1 ns

Note:

[1] Typical values are measured at $T_{amb}=25^{\circ}\text{C}$ and $V_{CC}=1.8\text{V}, 2.5\text{V}, 2.7\text{V}, 3.3\text{V}$ and 5.0V respectively.

3.3.4、AC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
nA to nY propagation delay	t_{pd}	see Figure 4	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	22.0	ns
			$V_{CC}=2.3\text{V to }2.7\text{V}$	-	15.0	ns
			$V_{CC}=2.7\text{V}$	-	15.8	ns
			$V_{CC}=3.0\text{V to }3.6\text{V}$	-	13.6	ns
			$V_{CC}=4.5\text{V to }5.5\text{V}$	-	10.7	ns
nOE to nY enable time	t_{en}	see Figure 5	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	23.1	ns
			$V_{CC}=2.3\text{V to }2.7\text{V}$	-	14.7	ns
			$V_{CC}=2.7\text{V}$	-	15.8	ns
			$V_{CC}=3.0\text{V to }3.6\text{V}$	-	13.4	ns
			$V_{CC}=4.5\text{V to }5.5\text{V}$	-	10.2	ns
nOE to nY disable time	t_{dis}	see Figure 5	$V_{CC}=1.65\text{V to }1.95\text{V}$	-	18.2	ns
			$V_{CC}=2.3\text{V to }2.7\text{V}$	-	11.3	ns
			$V_{CC}=2.7\text{V}$	-	17.4	ns
			$V_{CC}=3.0\text{V to }3.6\text{V}$	-	14.6	ns
			$V_{CC}=4.5\text{V to }5.5\text{V}$	-	10.8	ns

4、Testing Circuit

4.1、AC Testing Circuit

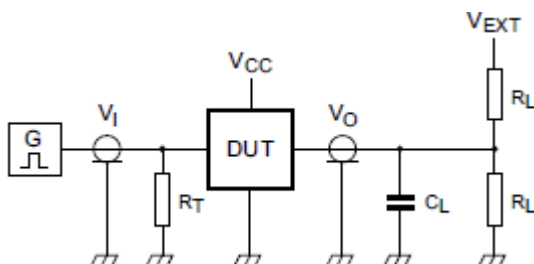


Figure 3. Test circuit for measuring switching times

Definitions for test circuit:

R_L =Load resistance.

C_L =Load capacitance including jig and probe capacitance.

R_T =Termination resistance; should be equal to the output impedance Z_o of the pulse generator.

V_{EXT} =External voltage for measuring switching times.

4.2、AC Testing Waveforms

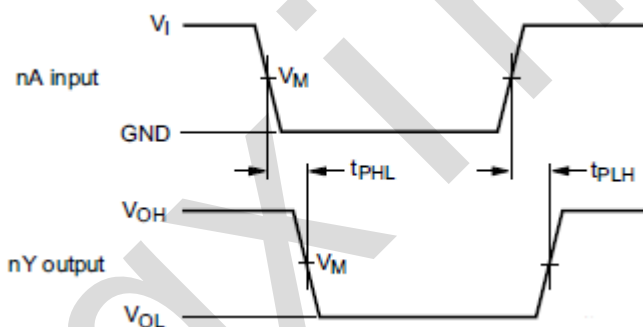


Figure 4. The input (nA) to output (nY) propagation delays

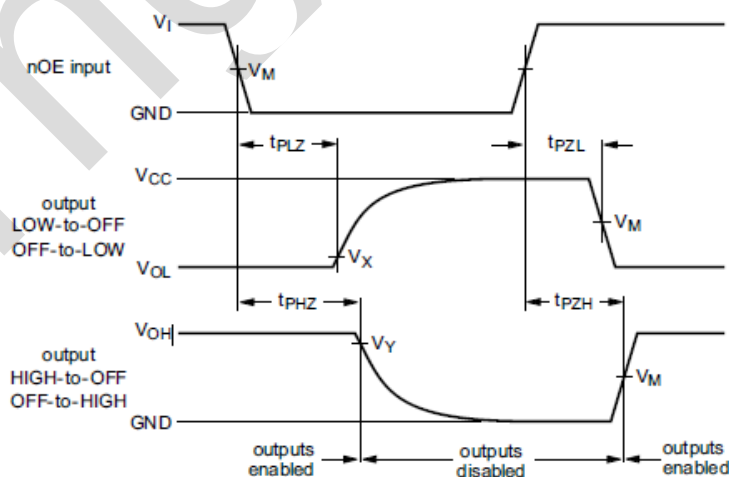


Figure 5. 3-state enable and disable times



4.3、Measurement Points

Supply voltage	Input	Output		
V_{CC}	V_M	V_M	V_X	V_Y
1.65V to 1.95V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL}+0.15V$	$V_{OH}-0.15V$
2.3V to 2.7V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL}+0.15V$	$V_{OH}-0.15V$
2.7V	1.5V	1.5V	$V_{OL}+0.3V$	$V_{OH}-0.3V$
3.0V to 3.6V	1.5V	1.5V	$V_{OL}+0.3V$	$V_{OH}-0.3V$
4.5V to 5.5V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL}+0.3V$	$V_{OH}-0.3V$

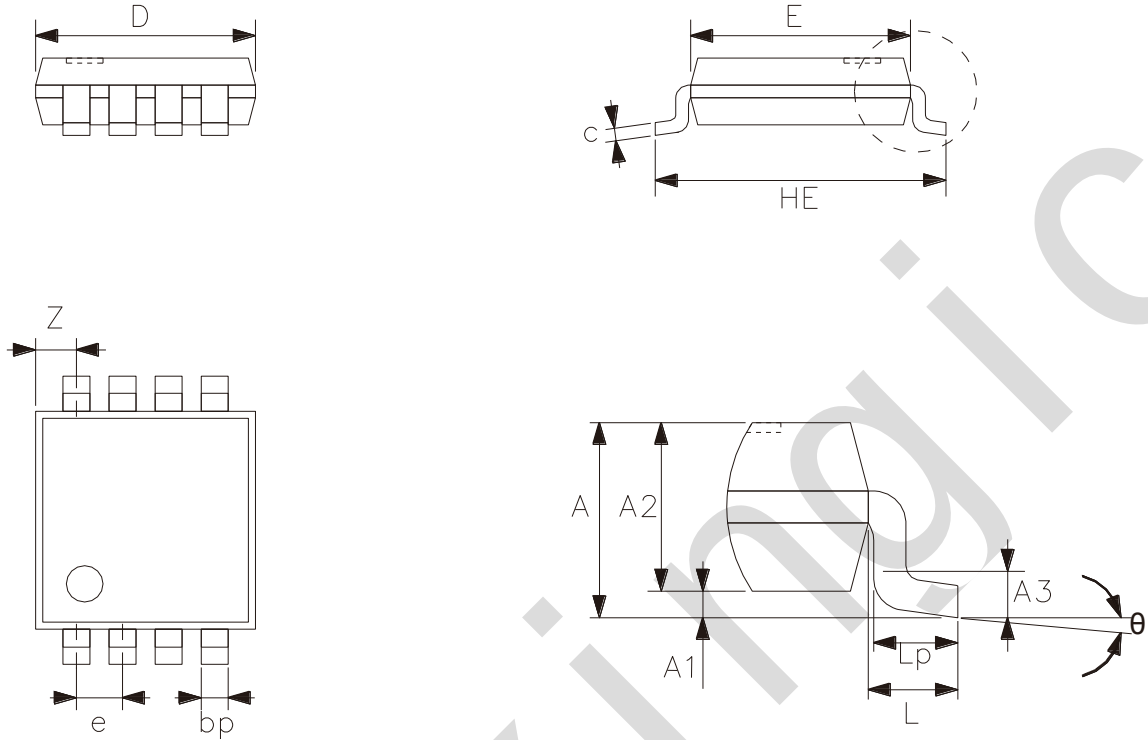
4.4、Test Data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	$t_r = t_f$	C_L	R_L	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
1.65V to 1.95V	V_{CC}	$\leq 3ns$	30pF	1k Ω	open	GND	$2 \times V_{CC}$
2.3V to 2.7V	V_{CC}	$\leq 3ns$	30pF	500 Ω	open	GND	$2 \times V_{CC}$
2.7V	2.7V	$\leq 3ns$	50pF	500 Ω	open	GND	6V
3.0V to 3.6V	2.7V	$\leq 3ns$	50pF	500 Ω	open	GND	6V
4.5V to 5.5V	V_{CC}	$\leq 3ns$	50pF	500 Ω	open	GND	$2 \times V_{CC}$



5、Package Information

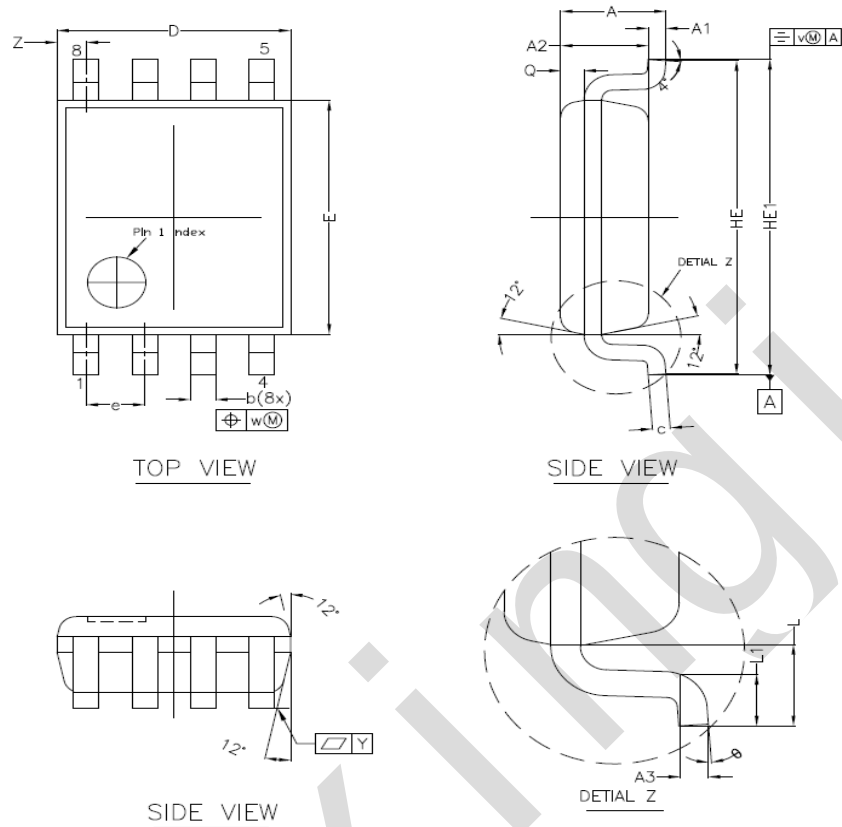
5.1、TSSOP8



Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.10
A1	0	0.15
A2	0.75	0.95
A3	0.25	
bp	0.22	0.38
c	0.08	0.18
D	2.90	3.10
E	2.90	3.10
HE	3.90	4.10
L	0.50	
Lp	0.33	0.47
e	0.65	
Z	0.35	0.70
θ	0°	8°



5.2、VSSOP8



Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.00
A1	0.00	0.15
A2	0.60	0.85
A3	0.12	
Q	0.19	0.21
b	0.17	0.27
c	0.08	0.23
D	1.90	2.10
E	2.20	2.40
HE	3.00	3.20
HE1	3.00	3.40
e	0.50	
L	0.40	
L1	0.15	0.40
Y	0.10	
Z	0.10	0.40
θ	0°	8°



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notes

We Recommend you to read this chapter carefully before using this product.

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